



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

74HC283

4-bit binary full adder with fast carry

Rev. 03 — 11 November 2004

Product data sheet

1. General description

The 74HC283 is a high-speed Si-gate CMOS device and is pin compatible with low power Schottky TTL (LSTTL). The 74HC283 is specified in compliance with JEDEC standard no. 7A.

The 74HC283 adds two 4-bit binary words (A_n plus B_n) plus the incoming carry (CIN). The binary sum appears on the sum outputs (S1 to S4) and the out-going carry (COUT) according to the equation:

$$\begin{aligned} \text{CIN} + (A_1 + B_1) + 2(A_2 + B_2) + 4(A_3 + B_3) + 8(A_4 + B_4) = \\ = S_1 + 2S_2 + 4S_3 + 8S_4 + 16\text{COUT} \end{aligned}$$

Where (+) = plus.

Due to the symmetry of the binary add function, the 74HC283 can be used with either all active HIGH operands (positive logic) or all active LOW operands (negative logic). In case of all active LOW operands the results S1 to S4 and COUT should be interpreted also as active LOW. With active HIGH inputs, CIN must be held LOW when no carry in is intended. Interchanging inputs of equal weight does not affect the operation, thus CIN, A1, B1 can be assigned arbitrarily to pins 5, 6, 7, etc.

See the 74HC583 for the BCD version.

2. Features

- High-speed 4-bit binary addition
- Cascadable in 4-bit increments
- Fast internal look-ahead carry
- Low-power dissipation
- Complies with JEDEC standard no. 7A
- ESD protection:
 - ◆ HBM EIA/JESD22-A114-B exceeds 2000 V
 - ◆ MM EIA/JESD22-A115-A exceeds 200 V.
- Multiple package options
- Specified from -40°C to $+80^{\circ}\text{C}$ and from -40°C to $+125^{\circ}\text{C}$.

PHILIPS



5. Functional diagram

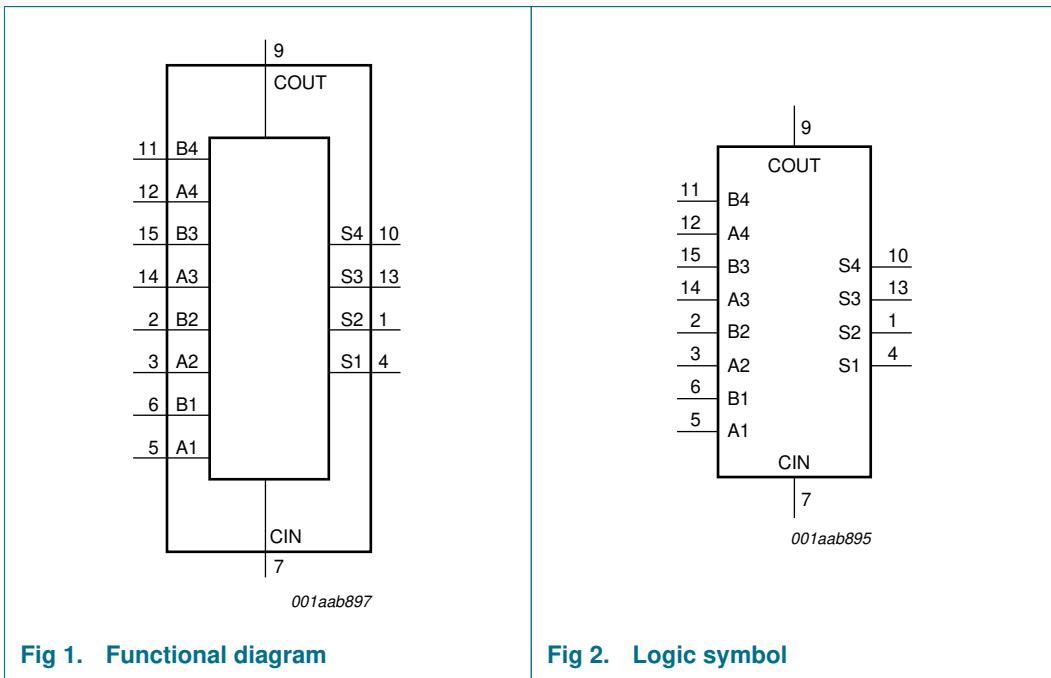


Fig 1. Functional diagram

Fig 2. Logic symbol

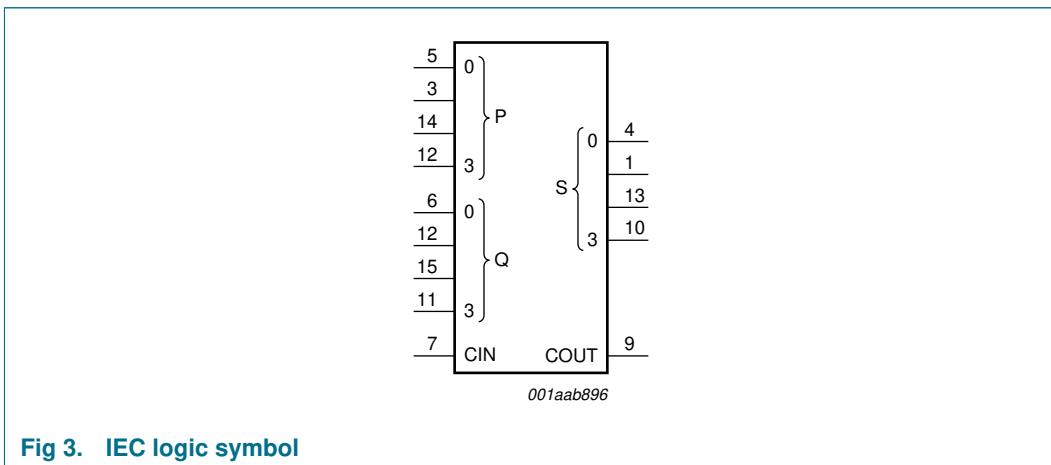


Fig 3. IEC logic symbol

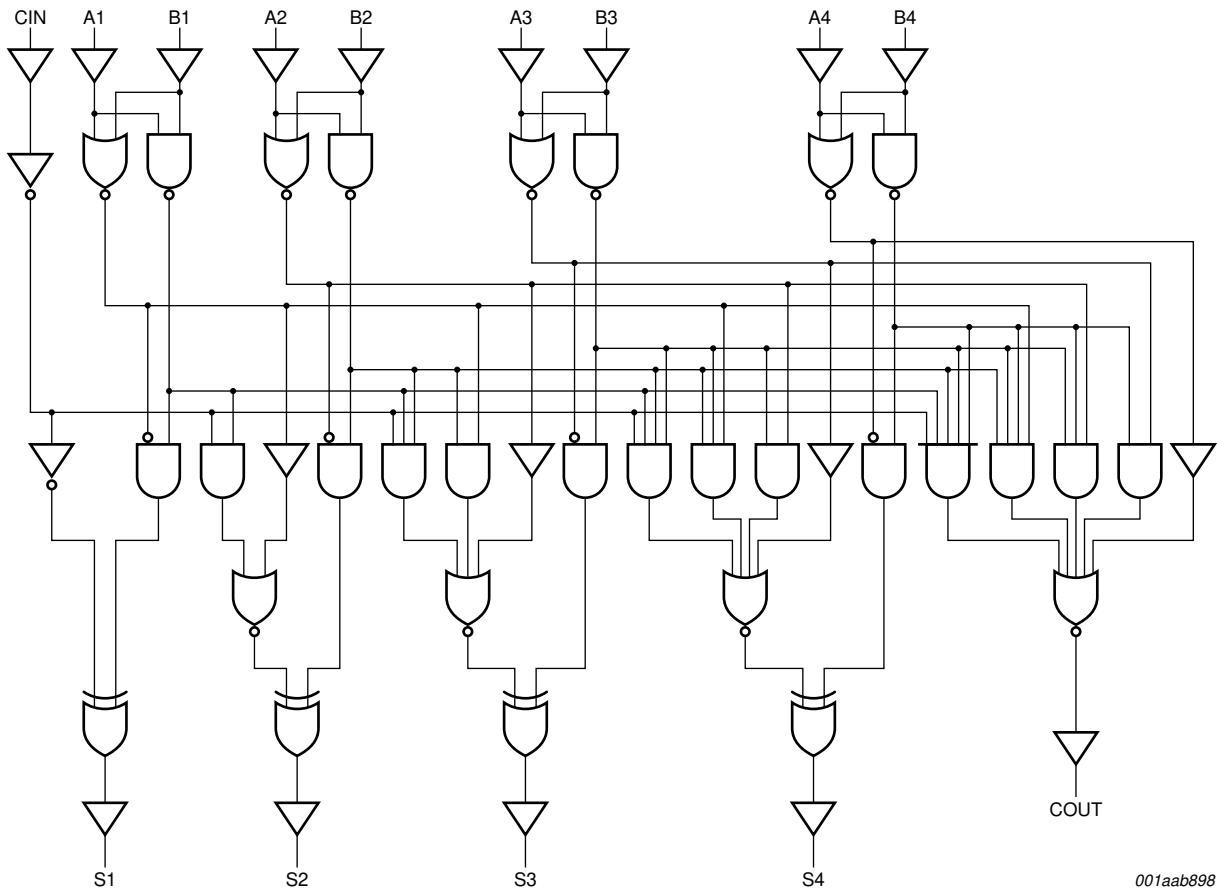


Fig 4. Logic diagram

6. Pinning information

6.1 Pinning

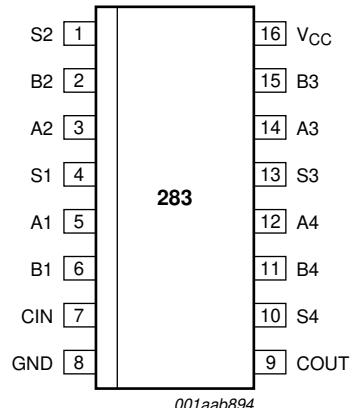


Fig 5. Pin configuration

8. Limiting values

Table 5: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7	V
I _{IK}	input diode current	V _I < -0.5 V or V _I > V _{CC} + 0.5 V	-	±20	mA
I _{OK}	output diode current	V _O < -0.5 V or V _O > V _{CC} + 0.5 V	-	±20	mA
I _O	output source or sink current	V _O = -0.5 V to V _{CC} + 0.5 V	-	±25	mA
I _{CC} , I _{GND}	V _{CC} or GND current		-	±50	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	power dissipation				
	DIP16 package	[1] -	750	mW	
	SO16, SSOP16 and TSSOP16 packages	[2] -	500	mW	

[1] Above 70 °C: P_{tot} derates linearly with 12 mW/K.

[2] Above 70 °C: P_{tot} derates linearly with 8 mW/K.

9. Recommended operating conditions

Table 6: Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V _{CC}	supply voltage		2.0	5.0	6.0	V
V _I	input voltage		0	-	V _{CC}	V
V _O	output voltage		0	-	V _{CC}	V
t _r , t _f	input rise and fall times	V _{CC} = 2.0 V V _{CC} = 4.5 V V _{CC} = 6.0 V	-	-	1000 500 400	ns
T _{amb}	ambient temperature		-40	-	+125	°C

12. Waveforms

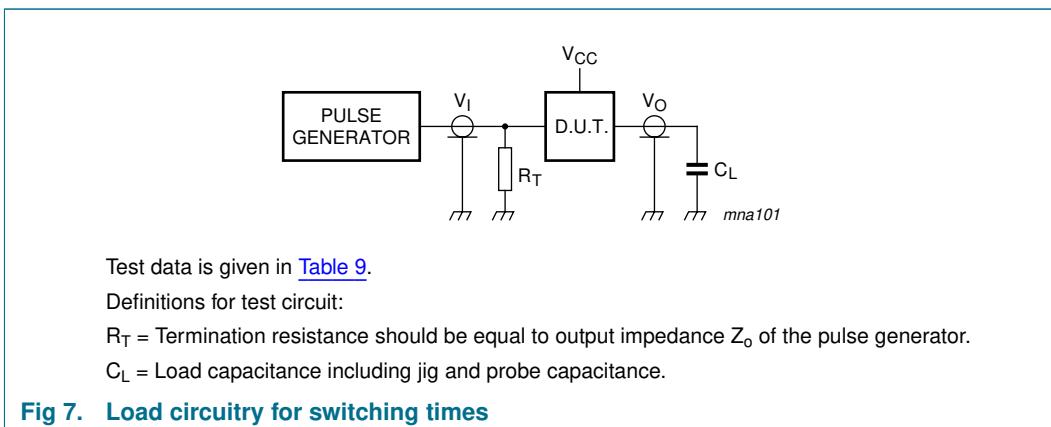
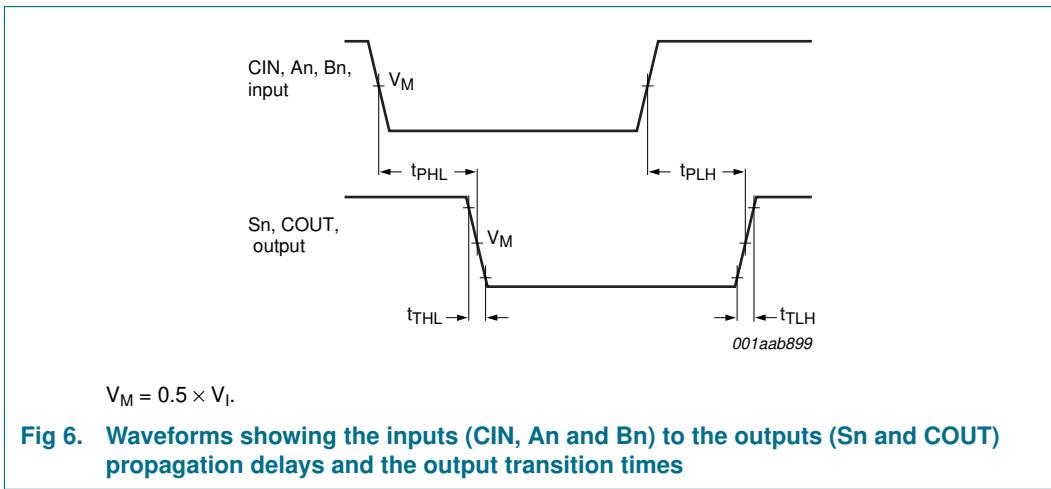


Table 9: Test data

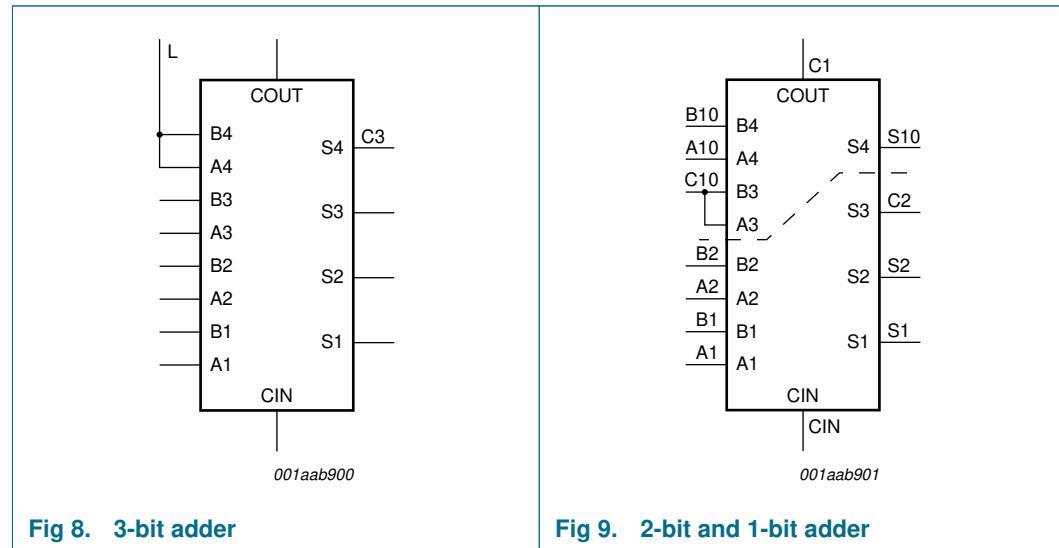
Supply	Input		Load
V_{CC}	V_I	t_r, t_f	C_L
2.0 V	V_{CC}	6 ns	50 pF
4.5 V	V_{CC}	6 ns	50 pF
6.0 V	V_{CC}	6 ns	50 pF
5.0 V	V_{CC}	6 ns	15 pF

13. Application information

[Figure 8](#) shows a 3-bit adder using the 74HC283. Trying the operand inputs of the fourth adder (A4 and B4) LOW makes S4 dependent on, and equal to, the carry from the third adder.

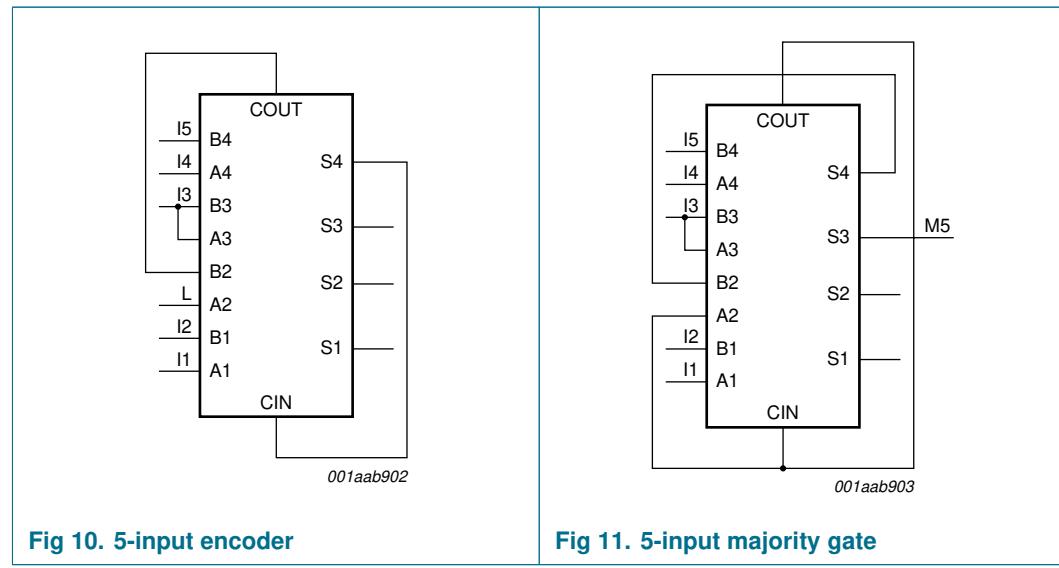
[Figure 9](#), based on the same principle, shows a method of dividing the 74HC283 into a 2-bit and 1-bit adder. The third stage adder (A3, B3 and S3) is used simply as means of transferring the carry into the fourth stage (via A3 and B3) and transferring the carry from

the second stage on S3. As long as A3 and B3 are the same, HIGH or LOW, they do not influence S3. Similarly, when A3 and B3 are the same, the carry into the third stage does not influence the carry out of the third stage.



[Figure 10](#) shows a method of implementing a 5-input encoder, where the inputs are equally weighted. The outputs S1, S2 and S3 produce a binary number equal to the number inputs (I1 to I5) that are HIGH.

[Figure 11](#) shows a method of implementing a 5-input majority gate. When three or more inputs (I1 to I5) are HIGH, the output M5 is HIGH.



14. Package outline

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4

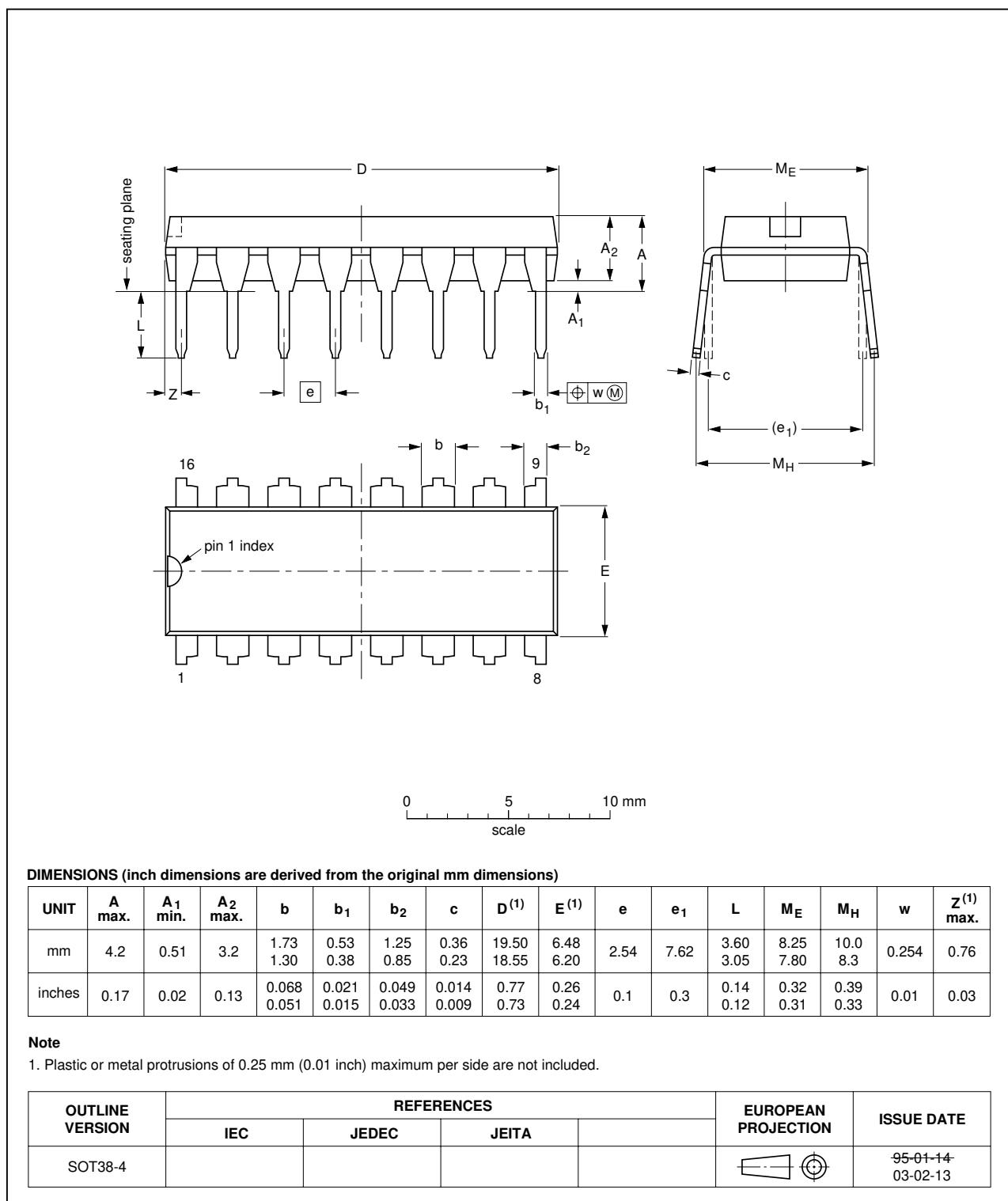


Fig 12. Package outline SOT38-4 (DIP16)

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

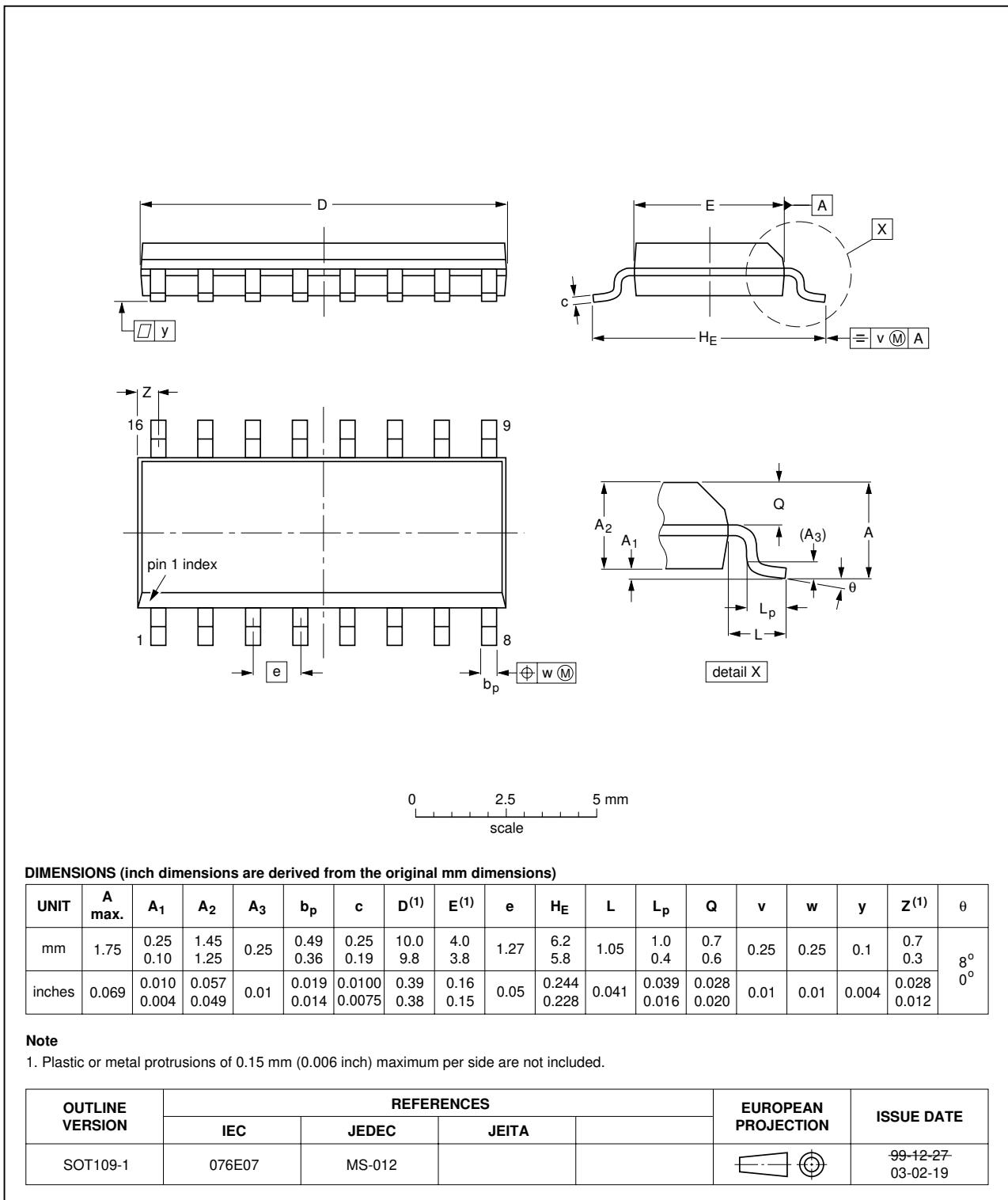


Fig 13. Package outline SOT109-1 (SO16)

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1

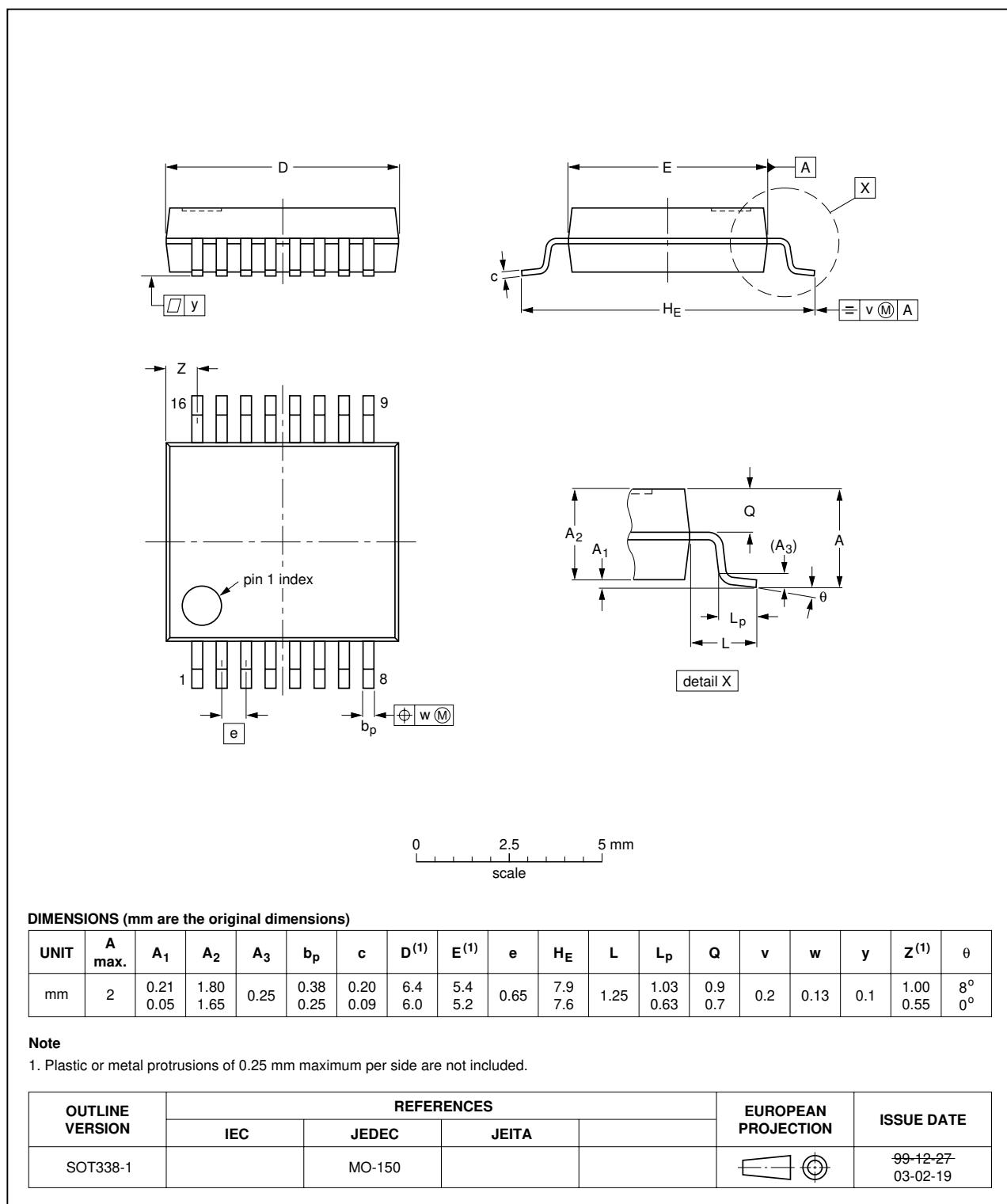


Fig 14. Package outline SOT338-1 (SSOP16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

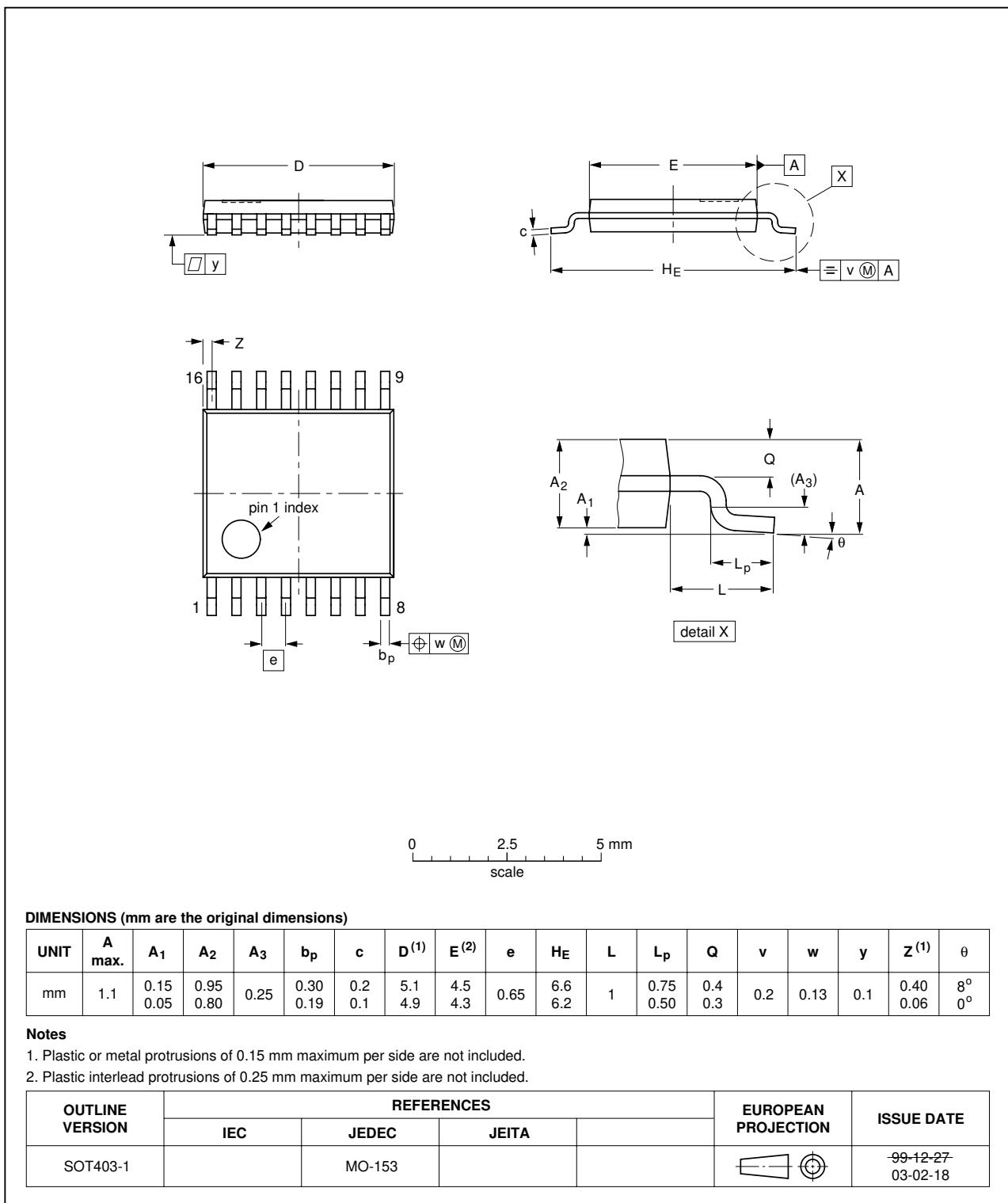


Fig 15. Package outline SOT403-1 (TSSOP16)



15. Revision history

Table 10: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
74HC283_3	20041111	Product data sheet	-	9397 750 13811	74HC_HCT283_CNV_2
Modifications:					<ul style="list-style-type: none">The format of this data sheet has been redesigned to comply with the current presentation and information standard of Philips Semiconductors.Removed type number 74HCT283.Inserted family specification.
74HC_HCT283_CNV_2	19970828	Product specification	-	-	74HC_HCT283_1
74HC_HCT283_1	19901201	Product specification	-	-	-

16. Data sheet status

Level	Data sheet status [1]	Product status [2][3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

17. Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

18. Disclaimers

Life support — These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes in the products - including circuits, standard cells, and/or software - described or contained herein in order to improve design and/or performance. When the product is in full production (status 'Production'), relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN). Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

19. Contact information

For additional information, please visit: <http://www.semiconductors.philips.com>

For sales office addresses, send an email to: sales.addresses@www.semiconductors.philips.com



20. Contents

1	General description	1
2	Features	1
3	Quick reference data	2
4	Ordering information	2
5	Functional diagram	3
6	Pinning information	4
6.1	Pinning	4
6.2	Pin description	5
7	Functional description	5
7.1	Function table	5
8	Limiting values	6
9	Recommended operating conditions	6
10	Static characteristics	7
11	Dynamic characteristics	9
12	Waveforms	12
13	Application information	12
14	Package outline	14
15	Revision history	18
16	Data sheet status	19
17	Definitions	19
18	Disclaimers	19
19	Contact information	19

© Koninklijke Philips Electronics N.V. 2004

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

Date of release: 11 November 2004
Document number: 9397 750 13811



Published in The Netherlands